# 74HC573; 74HCT573

Octal D-type transparent latch; 3-state

Rev. 7 — 4 March 2016

**Product data sheet** 

#### 1. **General description**

The 74HC573; 74HCT573 is an 8-bit D-type transparent latch with 3-state outputs. The device features latch enable (LE) and output enable (OE) inputs. When LE is HIGH, data at the inputs enter the latches. In this condition the latches are transparent, a latch output will change each time its corresponding D-input changes. When LE is LOW the latches store the information that was present at the inputs a set-up time preceding the HIGH-to-LOW transition of LE. A HIGH on OE causes the outputs to assume a high-impedance OFF-state. Operation of the OE input does not affect the state of the latches. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V<sub>CC</sub>.

#### 2. **Features and benefits**

- Input levels:
  - ◆ For 74HC573: CMOS level
  - ◆ For 74HCT573: TTL level
- Inputs and outputs on opposite sides of package allowing easy interface with microprocessors
- Useful as input or output port for microprocessors and microcomputers
- 3-state non-inverting outputs for bus-oriented applications
- Common 3-state output enable input
- Multiple package options
- Complies with JEDEC standard no. 7 A
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 2 000 V
  - ◆ MM JESD22-A115-A exceeds 200 V
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

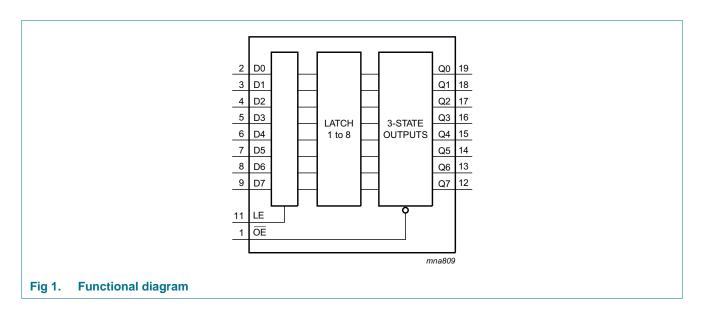


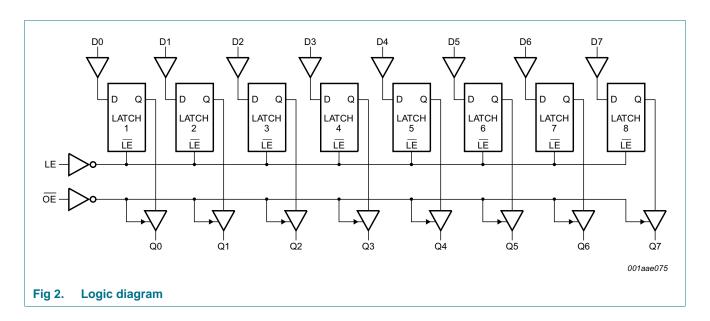
# 3. Ordering information

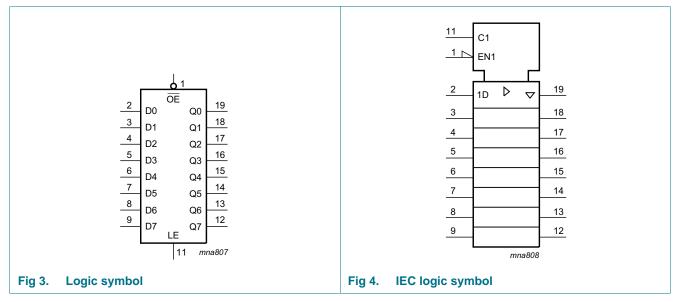
Table 1. Ordering information

| Type number | Package           |          |  |          |
|-------------|-------------------|----------|--|----------|
|             | Temperature range | Name     | Description  | Version  |
| 74HC573D    | −40 °C to +125 °C | SO20     | plastic small outline package; 20 leads;   | SOT163-1 |
| 74HCT573D   |                   |          | body width 7.5 mm  |          |
| 74HC573DB   | −40 °C to +125 °C | SSOP20   | plastic shrink small outline package; 20 leads;                                      | SOT339-1 |
| 74HCT573DB  |                   |          | body width 5.3 mm  |          |
| 74HC573PW   | –40 °C to +125 °C | TSSOP20  | plastic thin shrink small outline package; 20 leads;                                 | SOT360-1 |
| 74HCT573PW  |                   |          | body width 4.4 mm  |          |
| 74HC573BQ   | –40 °C to +125 °C | DHVQFN20 | plastic dual in-line compatible thermal enhanced very                                | SOT764-1 |
| 74HCT573BQ  |                   |          | thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm |          |

# 4. Functional diagram

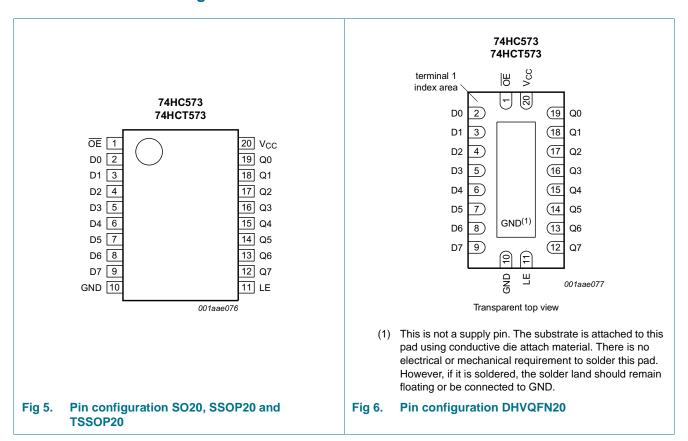






# 5. Pinning information

### 5.1 Pinning



### 5.2 Pin description

Table 2. Pin description

| Symbol | Pin                            | Description                              |
|--------|--------------------------------|--|
| ŌĒ     | 1                              | 3-state output enable input (active LOW) |
| D[0:7] | 2, 3, 4, 5, 6, 7, 8, 9         | data input                               |
| GND    | 10                             | ground (0 V)                             |
| LE     | 11                             | latch enable input (active HIGH)         |
| Q[0:7] | 19, 18, 17, 16, 15, 14, 13, 12 | 3-state latch output                     |
| Vcc    | 20                             | supply voltage                           |

# 6. Functional description

Table 3. Function table[1]

| Operating mode                        | Control |    | Input | Internal | Output |
|---------------------------------------|---------|----|-------|----------|--------|
|                                       | OE      | LE | Dn    | latches  | Qn     |
| Enable and read register (transparent | L       | Н  | L     | L        | L      |
| mode)                                 |         |    | Н     | Н        | Н      |
| Latch and read register               | L       | L  | I     | L        | L      |
|                                       |         |    | h     | Н        | Н      |
| Latch register and disable outputs    | Н       | L  | I     | L        | Z      |
|                                       |         |    | h     | Н        | Z      |

<sup>[1]</sup> H = HIGH voltage level;

h = HIGH voltage level one set-up time prior to the HIGH-to-LOW LE transition;

## 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions  | Min  | Max  | Unit |
|------------------|-------------------------|---|------|------|------|
| V <sub>CC</sub>  | supply voltage          |   | -0.5 | +7   | V    |
| I <sub>IK</sub>  | input clamping current  | $V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$ | -    | ±20  | mA   |
| I <sub>OK</sub>  | output clamping current | $V_{O} < -0.5 \text{ V or } V_{O} > V_{CC} + 0.5 \text{ V}$ | -    | ±20  | mA   |
| Io               | output current          | $V_{O} = -0.5 \text{ V to } (V_{CC} + 0.5 \text{ V})$       | -    | ±35  | mA   |
| I <sub>CC</sub>  | supply current          |   | -    | +70  | mA   |
| $I_{GND}$        | ground current          |   | -70  | -    | mA   |
| T <sub>stg</sub> | storage temperature     |   | -65  | +150 | °C   |
| P <sub>tot</sub> | total power dissipation | SO20, SSOP20, TSSOP20 and DHVQFN20 [1] packages             | -    | 500  | mW   |

<sup>[1]</sup> For SO20: P<sub>tot</sub> derates linearly with 8 mW/K above 70 °C.

For SSOP20 and TSSOP20 packages:  $P_{tot}$  derates linearly with 5.5 mW/K above 60 °C.

For DHVQFN20 package:  $P_{tot}$  derates linearly with 4.5 mW/K above 60  $^{\circ}\text{C}.$ 

L = LOW voltage level;

I = LOW voltage level one set-up time prior to the HIGH-to-LOW LE transition;

Z = high-impedance OFF-state.

# 8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

| Symbol           | Parameter                           | Conditions              |     | 74HC573 | 3               | 7   | 4HCT57 | 3               | Unit |
|------------------|-------------------------------------|-------------------------|-----|---------|-----------------|-----|--------|-----------------|------|
|                  |                                     |                         | Min | Тур     | Max             | Min | Тур    | Max             | _    |
| V <sub>CC</sub>  | supply voltage                      |                         | 2.0 | 5.0     | 6.0             | 4.5 | 5.0    | 5.5             | V    |
| VI               | input voltage                       |                         | 0   | -       | V <sub>CC</sub> | 0   | -      | V <sub>CC</sub> | V    |
| Vo               | output voltage                      |                         | 0   | -       | V <sub>CC</sub> | 0   | -      | V <sub>CC</sub> | V    |
| T <sub>amb</sub> | ambient temperature                 |                         | -40 | +25     | +125            | -40 | +25    | +125            | °C   |
| Δt/ΔV            | input transition rise and fall rate | V <sub>CC</sub> = 2.0 V | -   | -       | 625             | -   | -      | -               | ns/V |
|                  |                                     | V <sub>CC</sub> = 4.5 V | -   | 1.67    | 139             | -   | 1.67   | 139             | ns/V |
|                  |                                     | V <sub>CC</sub> = 6.0 V | -   | -       | 83              | -   | -      | -               | ns/V |

## 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol          | Parameter                | Conditions   |      | 25 °C |      | -40 °C t | o +85 °C | –40 °C t | Unit  |    |
|-----------------|--------------------------|--|------|-------|------|----------|----------|----------|-------|----|
|                 |                          |  | Min  | Тур   | Max  | Min      | Max      | Min      | Max   |    |
| 74HC573         | 3                        |  |      |       |      |          |          |          |       |    |
| V <sub>IH</sub> | HIGH-level               | V <sub>CC</sub> = 2.0 V  | 1.5  | 1.2   | -    | 1.5      | -        | 1.5      | -     | V  |
|                 | input voltage            | V <sub>CC</sub> = 4.5 V  | 3.15 | 2.4   | -    | 3.15     | -        | 3.15     | -     | V  |
|                 |                          | V <sub>CC</sub> = 6.0 V  | 4.2  | 3.2   | -    | 4.2      | -        | 4.2      | -     | V  |
| $V_{IL}$        | LOW-level                | V <sub>CC</sub> = 2.0 V  | -    | 0.8   | 0.5  | -        | 0.5      | -        | 0.5   | V  |
|                 | input voltage            | V <sub>CC</sub> = 4.5 V  | -    | 2.1   | 1.35 | -        | 1.35     | -        | 1.35  | V  |
|                 |                          | V <sub>CC</sub> = 6.0 V  | -    | 2.8   | 1.8  | -        | 1.8      | -        | 1.8   | V  |
| V <sub>OH</sub> | HIGH-level               | $V_I = V_{IH}$ or $V_{IL}$   |      |       |      |          |          |          |       |    |
| out             | output voltage           | $I_{O} = -20 \mu A; V_{CC} = 2.0 V$                                  | 1.9  | 2.0   | -    | 1.9      | -        | 1.9      | -     | V  |
|                 |                          | $I_O = -20 \mu A; V_{CC} = 4.5 V$                                    | 4.4  | 4.5   | -    | 4.4      | -        | 4.4      | -     | V  |
|                 |                          | $I_O = -20 \mu A; V_{CC} = 6.0 \text{ V}$                            | 5.9  | 6.0   | -    | 5.9      | -        | 5.9      | -     | V  |
|                 |                          | $I_O = -6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$                      | 3.98 | 4.32  | -    | 3.84     | -        | 3.7      | -     | V  |
|                 |                          | $I_O = -7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$                      | 5.48 | 5.81  | -    | 5.34     | -        | 5.2      | -     | V  |
| $V_{OL}$        | LOW-level                | $V_I = V_{IH}$ or $V_{IL}$   |      |       |      |          |          |          |       |    |
|                 | output voltage           | $I_O = 20 \mu A; V_{CC} = 2.0 V$                                     | -    | 0     | 0.1  | -        | 0.1      | -        | 0.1   | V  |
|                 |                          | $I_O = 20 \mu A; V_{CC} = 4.5 V$                                     | -    | 0     | 0.1  | -        | 0.1      | -        | 0.1   | V  |
|                 |                          | $I_O = 20 \mu A; V_{CC} = 6.0 \text{ V}$                             | -    | 0     | 0.1  | -        | 0.1      | -        | 0.1   | V  |
|                 |                          | $I_O = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$                       | -    | 0.15  | 0.26 | -        | 0.33     | -        | 0.4   | V  |
|                 |                          | $I_O = 7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$                       | -    | 0.16  | 0.26 | -        | 0.33     | -        | 0.4   | V  |
| I <sub>I</sub>  | input leakage<br>current | $V_I = V_{CC}$ or GND;<br>$V_{CC} = 6.0 \text{ V}$                   | -    | -     | ±0.1 | -        | ±1.0     | -        | ±1.0  | μΑ |
| l <sub>OZ</sub> | OFF-state output current | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 6.0$ V; $V_O = V_{CC}$ or GND | -    | -     | ±0.5 | -        | ±5.0     | -        | ±10.0 | μΑ |

 Table 6.
 Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter                 | Conditions  |      | 25 °C |      | –40 °C t | o +85 °C | -40 °C t | Unit |    |
|------------------|---------------------------|---|------|-------|------|----------|----------|----------|------|----|
|                  |                           |   | Min  | Тур   | Max  | Min      | Max      | Min      | Max  |    |
| I <sub>CC</sub>  | supply current            | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$  | -    | -     | 8.0  | -        | 80       | -        | 160  | μΑ |
| Cı               | input<br>capacitance      |   | -    | 3.5   | -    |          |          |          |      | pF |
| 74HCT5           | 73                        |   |      |       |      |          |          |          |      |    |
| $V_{IH}$         | HIGH-level input voltage  | V <sub>CC</sub> = 4.5 V to 5.5 V  | 2.0  | 1.6   | -    | 2.0      | -        | 2.0      | -    | V  |
| $V_{IL}$         | LOW-level input voltage   | V <sub>CC</sub> = 4.5 V to 5.5 V  | -    | 1.2   | 0.8  | -        | 0.8      | -        | 0.8  | V  |
| V <sub>OH</sub>  | HIGH-level                | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$   |      |       |      |          |          |          |      |    |
|                  | output voltage            | I <sub>O</sub> = -20 μA   | 4.4  | 4.5   | -    | 4.4      | -        | 4.4      | -    | V  |
|                  |                           | $I_O = -6 \text{ mA}$   | 3.98 | 4.32  | -    | 3.84     | -        | 3.7      | -    | V  |
| 0_               | LOW-level                 | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$   |      |       |      |          |          |          |      |    |
|                  | output voltage            | I <sub>O</sub> = 20 μA  | -    | 0     | 0.1  | -        | 0.1      | -        | 0.1  | V  |
| out an include   |                           | I <sub>O</sub> = 6.0 mA   | -    | 0.16  | 0.26 | -        | 0.33     | -        | 0.4  | V  |
| I <sub>I</sub>   | input leakage<br>current  | $V_I = V_{CC}$ or GND;<br>$V_{CC} = 5.5 \text{ V}$  | -    | -     | ±0.1 | -        | ±1.0     | -        | ±1.0 | μΑ |
| l <sub>OZ</sub>  | OFF-state output current  | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 5.5$ V; $V_O = V_{CC}$ or GND  | -    | -     | ±0.5 | -        | ±5.0     | -        | ±10  | μΑ |
| I <sub>CC</sub>  | supply current            | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$  | -    | -     | 8.0  | -        | 80       | -        | 160  | μΑ |
| Δl <sub>CC</sub> | additional supply current | $\begin{aligned} &V_I = V_{CC} - 2.1 \text{ V;} \\ &\text{other inputs at } V_{CC} \text{ or GND;} \\ &V_{CC} = 4.5 \text{ V to } 5.5 \text{ V;} \\ &I_O = 0 \text{ A} \end{aligned}$ |      |       |      |          |          |          |      |    |
|                  |                           | per input pin; Dn inputs  | -    | 35    | 126  | -        | 158      | -        | 172  | μΑ |
|                  |                           | per input pin; LE input   | -    | 65    | 234  | -        | 293      | -        | 319  | μΑ |
|                  |                           | per input pin; OE input   | -    | 125   | 450  | -        | 563      | -        | 613  | μΑ |
| Cı               | input<br>capacitance      |   | -    | 3.5   | -    | -        | -        | -        | -    | pF |

# 10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); C<sub>L</sub> = 50 pF unless otherwise specified; for test circuit see Figure 11.

| Symbol           | Parameter                           | Conditions                                    |       | 25 °C |     | -40 °C | to +85 °C | -40 °C to +125 °C |     | Unit |
|------------------|-------------------------------------|---|-------|-------|-----|--------|-----------|-------------------|-----|------|
|                  |                                     |   | Min   | Тур   | Max | Min    | Max       | Min               | Max |      |
| 74HC573          | 3                                   |   |       |       |     | 1      | 1         |                   |     |      |
| t <sub>pd</sub>  | propagation                         | Dn to Qn; see Figure 7                        | [1]   |       |     |        |           |                   |     |      |
|                  | delay                               | V <sub>CC</sub> = 2.0 V                       | -     | 47    | 150 | -      | 190       | -                 | 225 | ns   |
|                  |                                     | V <sub>CC</sub> = 4.5 V                       | -     | 17    | 30  | -      | 38        | -                 | 45  | ns   |
|                  |                                     | V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF | -     | 14    | -   | -      | -         | -                 | -   | ns   |
|                  |                                     | V <sub>CC</sub> = 6.0 V                       | -     | 14    | 26  | -      | 33        | -                 | 38  | ns   |
| t <sub>pd</sub>  | propagation                         | LE to Qn; see Figure 8                        | [1]   |       |     |        |           |                   |     |      |
|                  | delay                               | V <sub>CC</sub> = 2.0 V                       | -     | 50    | 150 | -      | 190       | -                 | 225 | ns   |
|                  |                                     | V <sub>CC</sub> = 4.5 V                       | -     | 18    | 30  | -      | 38        | -                 | 45  | ns   |
|                  |                                     | V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF | -     | 15    | -   | -      | -         | -                 | -   | ns   |
|                  |                                     | V <sub>CC</sub> = 6.0 V                       | -     | 14    | 26  | -      | 33        | -                 | 38  | ns   |
| t <sub>en</sub>  | enable time                         | OE to Qn; see Figure 9                        | [2]   |       |     |        |           |                   |     |      |
|                  |                                     | V <sub>CC</sub> = 2.0 V                       | -     | 44    | 140 | -      | 175       | -                 | 210 | ns   |
|                  |                                     | V <sub>CC</sub> = 4.5 V                       | -     | 16    | 28  | -      | 35        | -                 | 42  | ns   |
|                  |                                     | V <sub>CC</sub> = 6.0 V                       | -     | 13    | 24  | -      | 30        | -                 | 36  | ns   |
| t <sub>dis</sub> | disable time                        | OE to Qn; see Figure 9                        | [3]   |       |     |        |           |                   |     |      |
|                  |                                     | V <sub>CC</sub> = 2.0 V                       | -     | 55    | 150 | -      | 190       | -                 | 225 | ns   |
|                  |                                     | V <sub>CC</sub> = 4.5 V                       | -     | 20    | 30  | -      | 38        | -                 | 45  | ns   |
|                  |                                     | V <sub>CC</sub> = 6.0 V                       | -     | 16    | 26  | -      | 33        | -                 | 38  | ns   |
| t <sub>t</sub>   | transition                          | Qn; see Figure 7                              | [4]   |       |     |        |           |                   |     |      |
|                  | time                                | V <sub>CC</sub> = 2.0 V                       | -     | 14    | 60  | -      | 75        | -                 | 90  | ns   |
|                  |                                     | V <sub>CC</sub> = 4.5 V                       | -     | 5     | 12  | -      | 15        | -                 | 18  | ns   |
|                  |                                     | V <sub>CC</sub> = 6.0 V                       | -     | 4     | 10  | -      | 13        | -                 | 15  | ns   |
| t <sub>W</sub>   | pulse width                         | LE HIGH; see Figure 8                         |       |       |     |        |           |                   |     |      |
|                  |                                     | V <sub>CC</sub> = 2.0 V                       | 80    | 14    | -   | 100    | -         | 120               | -   | ns   |
|                  |                                     | V <sub>CC</sub> = 4.5 V                       | 16    | 5     | -   | 20     | -         | 24                | -   | ns   |
|                  |                                     | V <sub>CC</sub> = 6.0 V                       | 14    | 4     | -   | 17     | -         | 20                | -   | ns   |
| t <sub>su</sub>  | set-up time                         | Dn to LE; see Figure 10                       |       |       |     |        |           |                   |     |      |
|                  |                                     | V <sub>CC</sub> = 2.0 V                       | 50    | 11    | -   | 65     | -         | 75                | -   | ns   |
|                  |                                     | V <sub>CC</sub> = 4.5 V                       | 10    | 4     | -   | 13     | -         | 15                | -   | ns   |
|                  |                                     | V <sub>CC</sub> = 6.0 V                       | 9     | 3     | -   | 11     | -         | 13                | -   | ns   |
| t <sub>h</sub>   | hold time                           | Dn to LE; see Figure 10                       |       |       |     |        |           |                   |     |      |
|                  |                                     | V <sub>CC</sub> = 2.0 V                       | 5     | 3     | -   | 5      | -         | 5                 | -   | ns   |
|                  |                                     | V <sub>CC</sub> = 4.5 V                       | 5     | 1     | -   | 5      | -         | 5                 | -   | ns   |
|                  |                                     | V <sub>CC</sub> = 6.0 V                       | 5     | 1     | -   | 5      | -         | 5                 | -   | ns   |
| C <sub>PD</sub>  | power<br>dissipation<br>capacitance |   | [5] _ | 26    | -   | -      | -         | -                 | -   | pF   |

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 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V);  $C_L = 50 \text{ pF}$  unless otherwise specified; for test circuit see <u>Figure 11</u>.

| Symbol           | Parameter                           | Conditions  |     |     | 25 °C |     | -40 °C | to +85 °C | -40 °C t | o +125 °C | Unit |
|------------------|-------------------------------------|---|-----|-----|-------|-----|--------|-----------|----------|-----------|------|
|                  |                                     |   |     | Min | Тур   | Max | Min    | Max       | Min      | Max       |      |
| 74HCT5           | 73                                  |   |     |     |       |     |        |           | 1        |           | -1   |
| t <sub>pd</sub>  | propagation                         | Dn to Qn; see Figure 7  | [1] |     |       |     |        |           |          |           |      |
|                  | delay                               | V <sub>CC</sub> = 4.5 V   |     | -   | 20    | 35  | -      | 44        | -        | 53        | ns   |
|                  |                                     | V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF   |     | -   | 17    | -   | -      | -         | -        | -         | ns   |
| t <sub>pd</sub>  | propagation                         | LE to Qn; see Figure 8  | [1] |     |       |     |        |           |          |           |      |
|                  | delay                               | V <sub>CC</sub> = 4.5 V   |     | -   | 18    | 35  | -      | 44        | -        | 53        | ns   |
|                  |                                     | $V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$   |     | -   | 15    | -   | -      | -         | -        | -         | ns   |
| t <sub>en</sub>  | enable time                         | OE to Qn; see Figure 9  | [2] |     |       |     |        |           |          |           |      |
|                  |                                     | V <sub>CC</sub> = 4.5 V   |     | -   | 17    | 30  | -      | 38        | -        | 45        | ns   |
| t <sub>dis</sub> | disable time                        | OE to Qn; see Figure 9  | [3] |     |       |     |        |           |          |           |      |
|                  |                                     | V <sub>CC</sub> = 4.5 V   |     | -   | 18    | 30  | -      | 38        | -        | 45        | ns   |
| t <sub>t</sub>   | transition                          | Qn; see Figure 7  | [4] |     |       |     |        |           |          |           |      |
|                  | time                                | V <sub>CC</sub> = 4.5 V   |     | -   | 5     | 12  | -      | 15        | -        | 18        | ns   |
| t <sub>W</sub>   | pulse width                         | LE HIGH; see Figure 8   |     |     |       |     |        |           |          |           |      |
|                  |                                     | V <sub>CC</sub> = 4.5 V   |     | 16  | 5     | -   | 20     | -         | 24       | -         | ns   |
| t <sub>su</sub>  | set-up time                         | Dn to LE; see Figure 10   |     |     |       |     |        |           |          |           |      |
|                  |                                     | V <sub>CC</sub> = 4.5 V   |     | 13  | 7     | -   | 16     | -         | 20       | -         | ns   |
| t <sub>h</sub>   | hold time                           | Dn to LE; see Figure 10   |     |     |       |     |        |           |          |           |      |
|                  |                                     | V <sub>CC</sub> = 4.5 V   |     | 9   | 4     | -   | 11     | -         | 15       | -         | ns   |
| C <sub>PD</sub>  | power<br>dissipation<br>capacitance | $V_{CC} = 4.5 \text{ V}$ $C_L = 50 \text{ pF; } f = 1 \text{ MHz;}$ $V_I = \text{GND to } V_{CC} = 1.5 \text{ V}$ |     | -   | 26    | -   | -      | -         | -        | -         | pF   |

- [1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
- [2]  $t_{en}$  is the same as  $t_{PZH}$  and  $t_{PZL}$ .
- [3]  $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .
- [4]  $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .
- [5]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

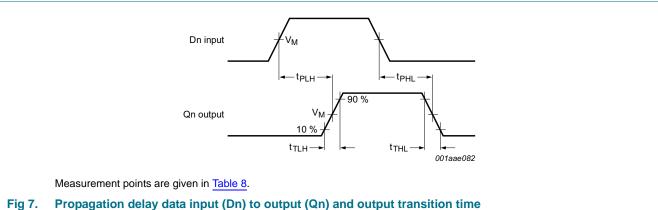
C<sub>L</sub> = output load capacitance in pF;

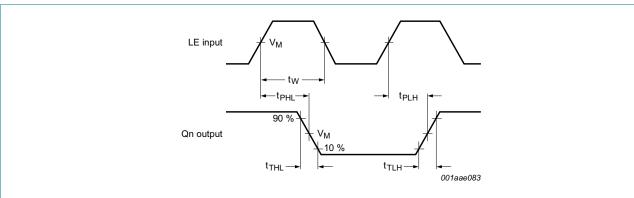
 $V_{CC}$  = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$ 

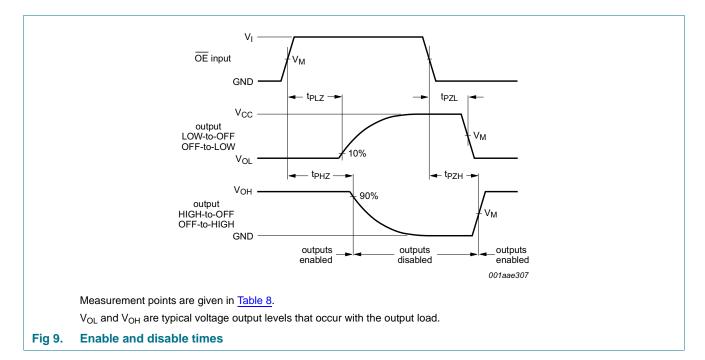
### 11. Waveforms





Measurement points are given in Table 8.

Fig 8. Pulse width latch enable input (LE), propagation delay latch enable input (LE) to output (Qn) and output transition time



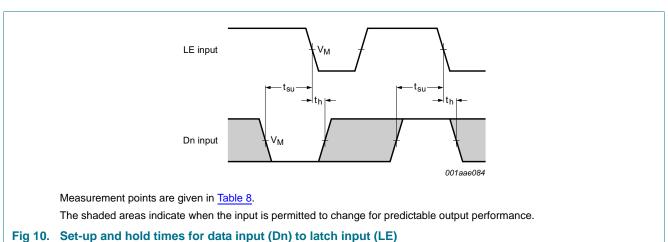
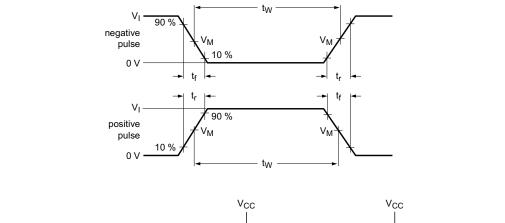
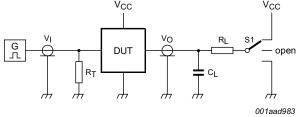


Table 8. Measurement points

| Туре     | Input              | Output             |
|----------|--------------------|--------------------|
|          | V <sub>M</sub>     | V <sub>M</sub>     |
| 74HC573  | 0.5V <sub>CC</sub> | 0.5V <sub>CC</sub> |
| 74HCT573 | 1.3 V              | 1.3 V              |





Test data is given in Table 9.

Definitions test circuit:

 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

 $C_L$  = Load capacitance including jig and probe capacitance.

R<sub>L</sub> = Load resistance.

S1 = Test selection switch.

Fig 11. Test circuit for measuring switching times

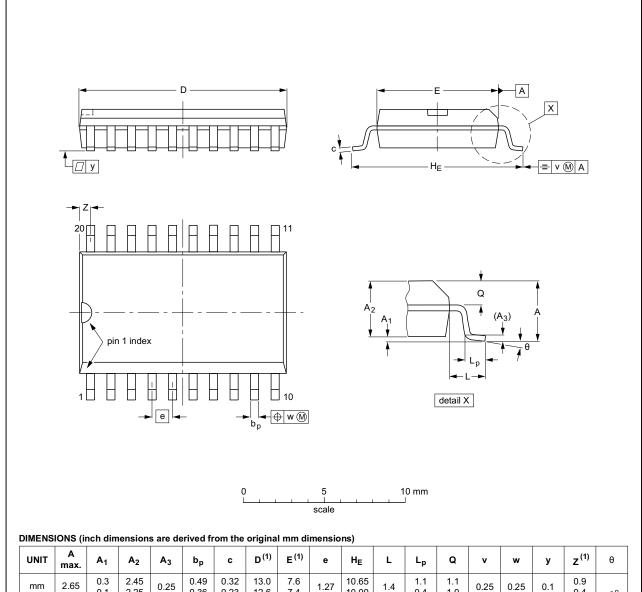
Table 9. Test data

| Туре     | Input           |                                 | Load         |                | S1 position                         |                                     |                                     |  |  |
|----------|-----------------|---------------------------------|--------------|----------------|-------------------------------------|-------------------------------------|-------------------------------------|--|--|
|          | VI              | t <sub>r</sub> , t <sub>f</sub> | CL           | R <sub>L</sub> | t <sub>PHL</sub> , t <sub>PLH</sub> | t <sub>PZH</sub> , t <sub>PHZ</sub> | t <sub>PZL</sub> , t <sub>PLZ</sub> |  |  |
| 74HC573  | V <sub>CC</sub> | 6 ns                            | 15 pF, 50 pF | 1 kΩ           | open                                | GND                                 | V <sub>CC</sub>                     |  |  |
| 74HCT573 | 3 V             | 6 ns                            | 15 pF, 50 pF | 1 kΩ           | open                                | GND                                 | V <sub>CC</sub>                     |  |  |

# 12. Package outline

### SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



| UNIT   | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | <b>A</b> <sub>3</sub> | bp             | С            | D <sup>(1)</sup> | E <sup>(1)</sup> | е    | HE             | L     | Lp             | Q          | ٧    | w    | у     | z <sup>(1)</sup> | θ  |
|--------|-----------|----------------|----------------|-----------------------|----------------|--------------|------------------|------------------|------|----------------|-------|----------------|------------|------|------|-------|------------------|----|
| mm     | 2.65      | 0.3<br>0.1     | 2.45<br>2.25   | 0.25                  | 0.49<br>0.36   | 0.32<br>0.23 | 13.0<br>12.6     | 7.6<br>7.4       | 1.27 | 10.65<br>10.00 | 1.4   | 1.1<br>0.4     | 1.1<br>1.0 | 0.25 | 0.25 | 0.1   | 0.9<br>0.4       | 8° |
| inches | 0.1       | 0.012<br>0.004 | 0.096<br>0.089 | 0.01                  | 0.019<br>0.014 |              | 0.51<br>0.49     | 0.30<br>0.29     | 0.05 | 0.419<br>0.394 | 0.055 | 0.043<br>0.016 |            | 0.01 | 0.01 | 0.004 | 0.035<br>0.016   | 0° |

#### Note

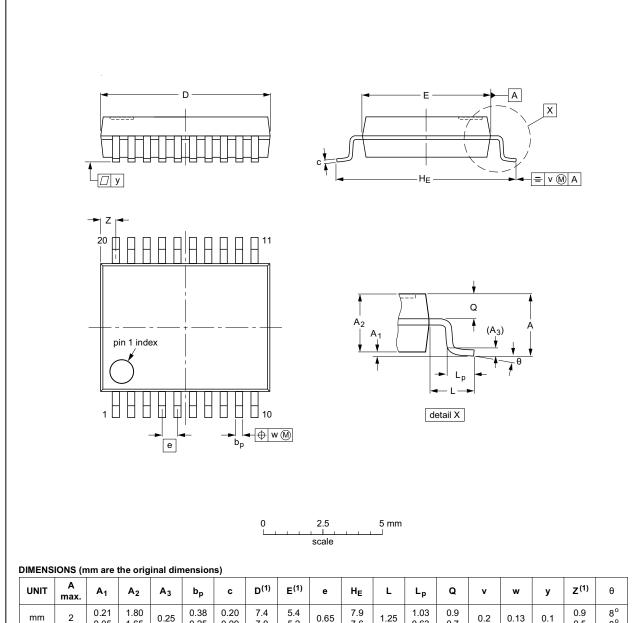
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

| OUTLINE  |        | REFER  | RENCES | EUROPEAN   | ISSUE DATE                      |  |
|----------|--------|--------|--------|------------|---------------------------------|--|
| VERSION  | IEC    | JEDEC  | JEITA  | PROJECTION | 1330E DATE                      |  |
| SOT163-1 | 075E04 | MS-013 |        |            | <del>99-12-27</del><br>03-02-19 |  |

Fig 12. Package outline SOT163-1 (SO20)

SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



| UNIT | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | <b>A</b> <sub>3</sub> | bp           | С            | D <sup>(1)</sup> | E <sup>(1)</sup> | е    | HE         | L    | Lp           | ø          | v   | ¥    | у   | Z <sup>(1)</sup> | θ        |
|------|-----------|----------------|----------------|-----------------------|--------------|--------------|------------------|------------------|------|------------|------|--------------|------------|-----|------|-----|------------------|----------|
| mm   | 2         | 0.21<br>0.05   | 1.80<br>1.65   | 0.25                  | 0.38<br>0.25 | 0.20<br>0.09 | 7.4<br>7.0       | 5.4<br>5.2       | 0.65 | 7.9<br>7.6 | 1.25 | 1.03<br>0.63 | 0.9<br>0.7 | 0.2 | 0.13 | 0.1 | 0.9<br>0.5       | 8°<br>0° |

#### Note

1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

| OUTLINE  |     | REFER  | ENCES | EUROPEAN   | ISSUE DATE                      |  |
|----------|-----|--------|-------|------------|---------------------------------|--|
| VERSION  | IEC | JEDEC  | JEITA | PROJECTION | 155UE DATE                      |  |
| SOT339-1 |     | MO-150 |       |            | <del>99-12-27</del><br>03-02-19 |  |

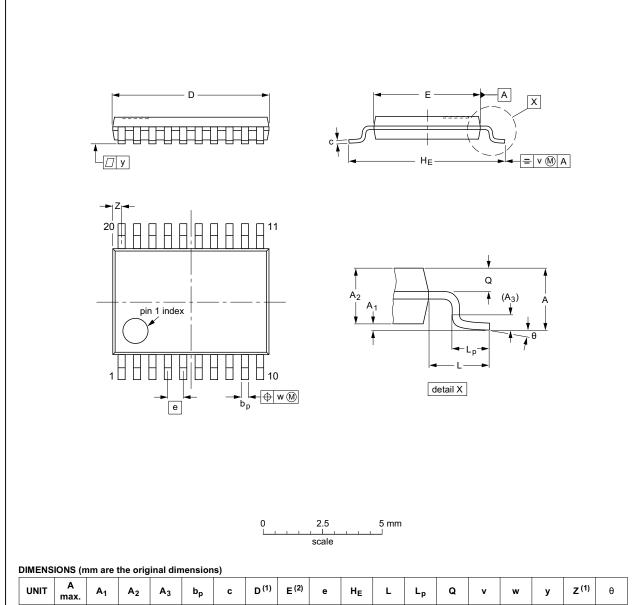
Fig 13. Package outline SOT339-1 (SSOP20)

74HC\_HCT573

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TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



| <br> |           |                |                | ,              |              | -,         |                  |            |      |            |   |              |            |     |      |     |                  |          |
|------|-----------|----------------|----------------|----------------|--------------|------------|------------------|------------|------|------------|---|--------------|------------|-----|------|-----|------------------|----------|
| UNIT | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | bp           | С          | D <sup>(1)</sup> | E (2)      | е    | HE         | L | Lp           | Q          | v   | w    | у   | Z <sup>(1)</sup> | θ        |
| mm   | 1.1       | 0.15<br>0.05   | 0.95<br>0.80   | 0.25           | 0.30<br>0.19 | 0.2<br>0.1 | 6.6<br>6.4       | 4.5<br>4.3 | 0.65 | 6.6<br>6.2 | 1 | 0.75<br>0.50 | 0.4<br>0.3 | 0.2 | 0.13 | 0.1 | 0.5<br>0.2       | 8°<br>0° |

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

|     | REFER  | RENCES    | EUROPEAN        | ISSUE DATE                      |
|-----|--------|-----------|-----------------|---------------------------------|
| IEC | JEDEC  | JEITA     | PROJECTION      | ISSUE DATE                      |
|     | MO-153 |           |                 | <del>99-12-27</del><br>03-02-19 |
|     | IEC    | IEC JEDEC | IEC JEDEC JEITA | IEC JEDEC JEITA PROJECTION      |

Fig 14. Package outline SOT360-1 (TSSOP20)

74HC\_HCT573

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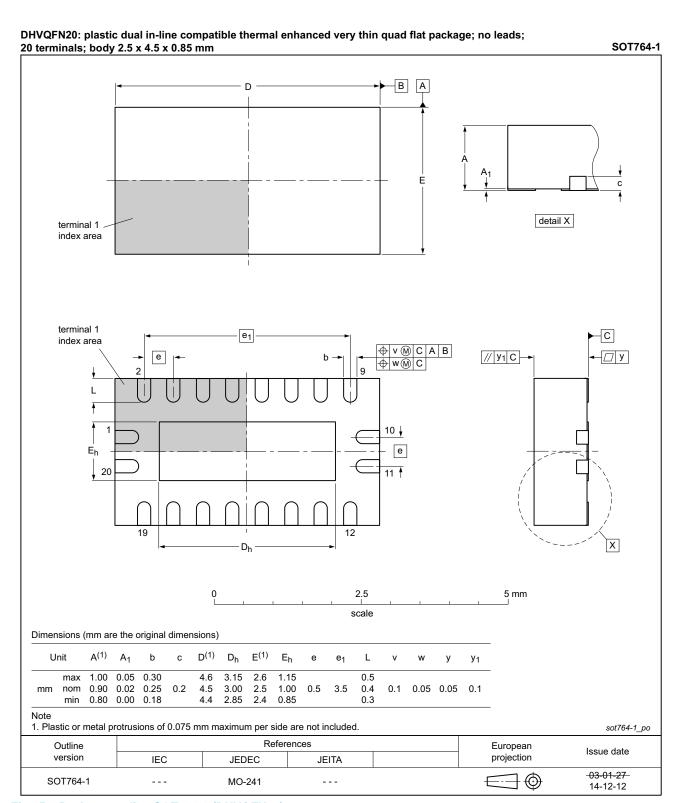


Fig 15. Package outline SOT764-1 (DHVQFN20)

74HC\_HCT573

**Product data sheet** 

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# 13. Abbreviations

#### Table 10. Abbreviations

| Acronym | Description                             |
|---------|---|
| CMOS    | Complementary Metal Oxide Semiconductor |
| DUT     | Device Under Test                       |
| ESD     | ElectroStatic Discharge                 |
| НВМ     | Human Body Model                        |
| MM      | Machine Model                           |
| TTL     | Transistor-Transistor Logic             |

# 14. Revision history

### Table 11. Revision history

| Document ID         | Release date  | Data sheet status             | Change notice        | Supersedes          |  |  |  |  |
|---------------------|---|-------------------------------|----------------------|---------------------|--|--|--|--|
| 74HC_HCT573 v.7     | 20160304  | Product data sheet            | -                    | 74HC_HCT573 v.6     |  |  |  |  |
| Modifications:      | Type number   | ers 74HC573N and 74HCT        | 573N (SOT146-1) re   | moved.              |  |  |  |  |
| 74HC_HCT573 v.6     | 20150126  | Product data sheet            | -                    | 74HC_HCT573 v.5     |  |  |  |  |
| Modifications:      | • <u>Table 7</u> : Pov  | wer dissipation capacitanc    | e condition for 74HC | Γ573 is corrected.  |  |  |  |  |
| 74HC_HCT573 v.5     | 20120815  | Product data sheet            | -                    | 74HC_HCT573 v.4     |  |  |  |  |
| Modifications:      | Alternative of  | descriptive title corrected ( | errata).             |                     |  |  |  |  |
| 74HC_HCT573 v.4     | 20120806  | Product data sheet            | -                    | 74HC_HCT573 v.3     |  |  |  |  |
| Modifications:      | <ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul> |                               |                      |                     |  |  |  |  |
| 74HC_HCT573 v.3     | 20060117  | Product data sheet            | -                    | 74HC_HCT573_CNV v.2 |  |  |  |  |
| 74HC_HCT573_CNV v.2 | 19901201  | Product specification         | -                    | -                   |  |  |  |  |

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| Product [short] data sheet     | Production        | This document contains the product specification.                                     |

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- [2] The term 'short data sheet' is explained in section "Definitions"
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# 74HC573; 74HCT573

#### Octal D-type transparent latch; 3-state

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